

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT5117097

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YEE LOY LAM	08/29/2018
LONG CHENG KOH	08/29/2018
KIAN HIN VICTOR TEO	08/27/2018
RECEIVING PARTY DATA	
Name:	DENSELIGHT SEMICONDUCTORS PTE. LTD.
Street Address:	6 CHANGI NORTH STREET 2
City:	SINGAPORE
State/Country:	SINGAPORE
Postal Code:	498831
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15810491
CORRESPONDENCE DATA	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	646-292-8778
Email:	ipdocket@goldbergsegalla.com
Correspondent Name:	CHANDRAN IYER C/O GOLDBERG SEGALLA LLP
Address Line 1:	711 3RD AVENUE, SUITE 1900
Address Line 4:	NEW YORK, NEW YORK 10017
ATTORNEY DOCKET NUMBER:	4126-0003
NAME OF SUBMITTER:	LYNN LEHNERT
SIGNATURE:	/LYNN LEHNERT/
DATE SIGNED:	08/29/2018
Total Attachments: 4	
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ASSIGNMENT

WHEREAS, We, Yee Loy LAM, Long Cheng KOH, and Kian Hin Victor TEO (Assignor(s)), respectively, have invented certain new and useful improvements described and/or claimed in the below listed application(s) and seek to hereby assign all our rights, title, and interest in and to those inventions:

- 1) U.S. Application No. 15/810,491, filed November 13, 2017,

entitled

OPTOELECTRONIC ASSEMBLY FOR OPTICAL COUPLING

WHEREAS, Denselight Semiconductors Pte. Ltd., a Singaporean corporation, having a place of business at 6 Changi North Street 2, Singapore 498831, (Assignee), is desirous of acquiring the entire right, title, and interest in and to said invention, said application(s), and all Letters Patent(s) that may be granted therefrom in the United States, its territorial possessions, and in any and all foreign countries.

NOW, THEREFORE, in consideration of good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, we, by these presents do sell, assign, and transfer unto said Assignee and said Assignee's legal representatives, successors, and assigns, the full and exclusive right, title and interest, in the United States, its territorial possessions, and all foreign countries, to said invention(s) and said application(s), as well as any subsequent application(s) (including divisions, reissues, continuations, substitutions and renewals thereof) that claim(s) priority based upon the filing date of said application(s) and any and all Letters Patents, both domestic and foreign, that may or shall result therefrom, including the right to claim in respect of any subsequent United States and foreign patent applications and patents, the priority date of any of said applications under any United States statute and/or international convention or treaty;

We hereby authorize and request the Patent Office Officials in the United States, its territorial possessions, and any and all foreign countries to issue any and all of said Letters Patent, when

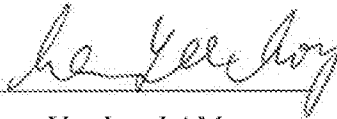
granted, to said ASSIGNEE as the assignees of our entire right, title, and interest in and to the same, for the sole use and benefit of said ASSIGNEE, their successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by us had this Assignment and sale not been made.

UPON CONSIDERATION, we do hereby covenant and agree with said Assignee that we will not execute any writing nor do any act whatsoever conflicting with these presents, and that we will at any time upon request, without further or additional consideration, execute such additional assignments and other writings and do such additional acts as said Assignee may deem necessary and desirable to perfect said Assignee's enjoyment of this grant, and render all necessary assistance in making an application for and obtaining provisional, original, continuation, continuation-in-part, divisional, reissued, re-examined or extended patents of the United States, its territorial possessions, or any and all foreign countries on said invention, and in enforcing any rights or causes of action in the United States, its territorial possessions, or any and all foreign countries accruing as a result of such applications or Letters Patents, including but not limited to, giving testimony in any proceedings or transactions involving such applications or patents, and executing preliminary statements and other affidavits, it being understood that the foregoing covenant and agreement shall bind and inure to the benefit of the assigns and legal representatives of all parties hereto.

The undersigned hereby grants the firm of Goldberg Segalla the power to insert on this assignment any further identification, including the application number and filing date, which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for the recordation of this document.

ASSIGNORS

Dated: 29 Aug 2018

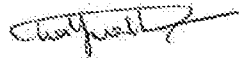


Yee Loy LAM

Title: CTO

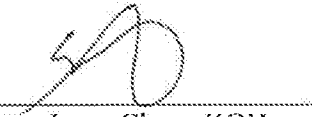
STATEMENT OF WITNESS

I, Chan Yuen Chuen whose full post address is 6 Dover Rise #15-02
Singapore 138678, was personally present and did witness, Yee Loy
LAM, who is known to me, execute the above assignment.



Signature of Witness

Dated: 29 Aug 2018

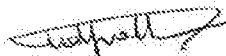


Long Cheng KOH

Title: Section Manager

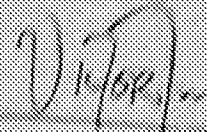
STATEMENT OF WITNESS

I, Chan Yuen Chuen, whose full post address is 6 Dover Rise #15-02
Singapore 138678, was personally present and did witness, Long
Cheng KOH, who is known to me, execute the above assignment.



Signature of Witness

Dated: 27 Aug 2018



Kian Hin Victor TEO
Title: Consultant, co-inventor

STATEMENT OF WITNESS

I, Lee Miow Kheng Valerie
whose full post address is BK 8 Ghim Moh Road
#03-273 S(270008), was personally present and did witness, Kian Hin
Victor TEO, who is known to me, execute the above assignment.



Signature of Witness

ASSIGNEE

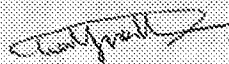
Dated: 29 Aug 2018



Rajan Rajgopal
Title: President and GM
Denselight Semiconductors

STATEMENT OF WITNESS

I, Gon Yuen Ching, whose full post address is 6 Bunka Pk #15-03
Singapore 138678, was personally present and did witness,
Rajan Rajgopal who is known to me, execute the above assignment.



Signature of Witness